Electronic Pa	tent App	lication Fee	Transm	ittal			
Application Number:	103	10789637					
Filing Date:	27-	27-Feb-2004					
Title of Invention:		FLIP CHIP SEMICONDUCTOR DIE INTERNAL SIGNAL ACCESS SYSTEM AND METHOD					
First Named Inventor/Applicant Name:	Bri	Brian S. Schieck					
Filer:	Joh	John F. Ryan/Donna Petford					
Attorney Docket Number:	NV	NVID-P001125					
Filed as Large Entity							
Utility under 35 USC 111(a) Filing Fees	;						
Description		Fee Code	Quantity	Amount	Sub-Total ir USD(\$)		
Basic Filing:					I		
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Utility Appl issue fee		1501	1	1510	1510		

Publ. Fee- early, voluntary, or normal

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
	Total in USD (\$)			1810